



**CHENMKO ENTERPRISE CO.,LTD**

Halogens free devices

**SURFACE MOUNT  
NPN SILICON Transistor**

**VOLTAGE 160 Volts CURRENT 0.6 Ampere**

**CHT5551ZGP**

#### APPLICATION

- \* Telephony and professional communication equipment.
- \* Other switching applications.

#### FEATURE

- \* Small flat package. ( SC-73/SOT-223 )
- \* Suitable for high packing density.

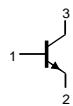
#### CONSTRUCTION

\*NPN SILICON Transistor

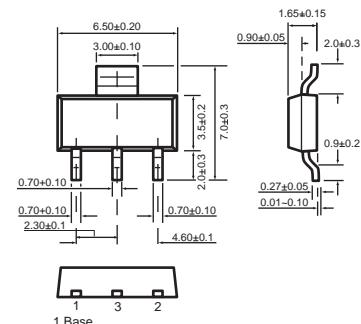
#### MARKING

ZFN

#### CIRCUIT



**SC-73/SOT-223**



Dimensions in millimeters

**SC-73/SOT-223**

#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	—	180	V
$V_{CEO}$	collector-emitter voltage	open base	—	160	V
$V_{EBO}$	emitter-base voltage	open collector	—	6.0	V
$I_C$	collector current (DC)		—	600	mA
$P_{tot}$	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$ ; note 1	—	2.0	W
$T_{stg}$	storage temperature		-65	+150	°C
$T_j$	junction temperature		—	150	°C
$T_{amb}$	operating ambient temperature		-65	+150	°C

#### Note

1. Transistor mounted on an FR4 printed-circuit board.

## RATING CHARACTERISTIC CURVES ( CHT5551ZGP )

### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient	note 1	357	K/W

#### Note

1.Transistor mounted on an FR4 printed-circuit board.

### CHARACTERISTICS

$T_{amb} = 25^{\circ}\text{C}$  unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$I_{CBO}$	collector cut-off current	$V_{CB} = 120\text{ V}$	—	50	nA
$I_{CBO}$	collector cut-off current	$V_{CB} = 120\text{ V}, T_A = 100^{\circ}\text{C}$	—	50	uA
$I_{EBO}$	emitter cut-off current	$V_{EB} = 4.0\text{V}$	—	50	nA
$h_{FE}$	DC current gain	$I_C = 1.0\text{ mA}; V_{CE} = 5\text{V}$ $I_C = 10\text{mA}; V_{CE} = 5\text{V}$ $I_C = 50\text{ mA}; V_{CE} = 5\text{V}$	80 80 30	— 250 —	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 10\text{ mA}; I_B = 1.0\text{ mA}$ $I_C = 50\text{ mA}; I_B = 5.0\text{ mA}$	— —	0.15 0.2	V
$V_{BEsat}$	base-emitter saturation voltage	$I_C = 10\text{mA}; I_B = 1.0\text{mA}$ $I_C = 50\text{ mA}; I_B = 5.0\text{ mA}$	— —	1.0 1.0	V
$C_{ob}$	collector capacitance	$I_E = i_e = 0; V_{CB} = 1.0\text{ V}; f = 1\text{ MHz}$	—	6.0	pF
$h_{fe}$		$V_{CE}=10\text{V}, I_C=1.0\text{mA}, f=1.0\text{KHz}$	50	200	
$f_T$	transition frequency	$I_C = 10\text{ mA}; V_{CE} = 1.0\text{ V}; f = 1.0\text{ MHz}$	100	300	MHz
F	noise figure	$I_C = 200\text{ mA}; V_{CE} = 5\text{ V}; R_S = 1.0\Omega; f = 10\text{Hz to } 15.7\text{KHz}$	—	8.0	dB